

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KOSTIANTYN MOROZOV	03/22/2021
OLEKSANDR KLIMENKOV	03/22/2021
DMYTRO VAVDIIUK	03/19/2021
IVAN SAFONOV	03/19/2021
ANDRII BUT	03/22/2021
ANDRII SUKHARIEV	03/18/2021
RUSLAN IERMOLENKO	03/22/2021
SERHII ILIUKHIN	03/17/2021
YAROSLAV LAVRENYUK	03/19/2021
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Name:	SAMSUNG ELECTRONICS CO., LTD
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17309033
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NAME OF SUBMITTER:	WILLIAM A. MUNCK

SIGNATURE:	/William A. Munck, Reg. No. 39,308/
DATE SIGNED:	04/15/2021
Total Attachments: 3 source=11_SAMS05-24646-Assignment1#page1.tif source=11_SAMS05-24646-Assignment1#page2.tif source=11_SAMS05-24646-Assignment1#page3.tif	

DOCKET NO.

PATENT

Client Ref. WU-201805-005-1-US0

ASSIGNMENT

WHEREAS, We, Kostiantyn MOROZOV, resident of Kyiv, Ukraine, Oleksandr KLIMENKOV, resident of Kyiv, Ukraine, Dmytro VAVDIHUK resident of Kyiv, Ukraine, Ivan SAFONOV, resident of Kyiv, Ukraine, Andrii BUT, resident of Kyiv, Ukraine, Andrii SUKHARIEV, resident of Kyiv, Ukraine, Ruslan IERMOLENKO, resident of Kyiv, Ukraine, Serhii ILIUKHIN, resident of Kyiv, Ukraine, Yaroslav LAVRENYUK, resident of Kyiv, Ukraine, have invented certain new and useful improvements in a "THREE-DIMENSIONAL DEPTH MEASURING DEVICE AND METHOD" disclosed in an application for United States Letters Patent (Application No. 17/309,033, filed on April 15, 2021), said application having been executed concurrently herewith;

WHEREAS, SAMSUNG ELECTRONICS CO., LTD., a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;


NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

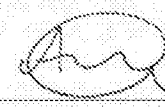
We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said

ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.


Date: 22.03.2021


Kostiantyn MOROZOV

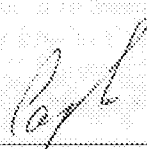
Date: 22 Mar 2021


Oleksandr KLIMENKOV

Date: 19.03.2021


Dmytro VAVDIUK

Date: 19.03.2021


Ivan SAFONOV

Date: 22.03.21


Andrii BU

Date: 18.03.2021



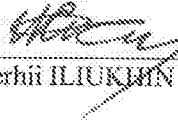
Andrii SUKHARIEV

Date: 22.03.2021



Ruslan IERMOLENKO

Date: 17.03.2021



Serhii ILIUKHIN

Date: 2021.03.19



Yaroslav LAVRENYUK